



ALPHA & OMEGA
SEMICONDUCTOR

AOW360A70/AOWF360A70

700V, α MOS5™ N-Channel Power Transistor

General Description

- Proprietary α MOS5™ technology
- Low $R_{DS(ON)}$
- Optimized switching parameters for better EMI performance
- Enhanced body diode for robustness and fast reverse recovery

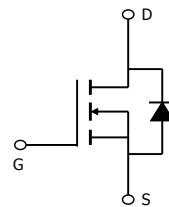
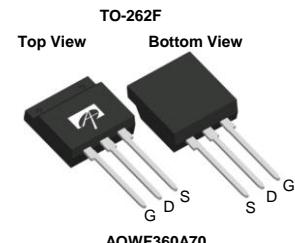
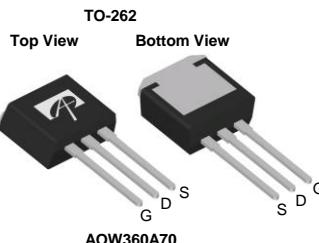
Product Summary

V_{DS} @ $T_{j,max}$	800V
I_{DM}	48A
$R_{DS(ON),max}$	< 0.36Ω
$Q_{g,typ}$	22.5nC
E_{oss} @ 400V	2.8μJ

Applications

- Flyback for SMPS
- Charger ,PD Adapter, TV, lighting.

100% UIS Tested
100% R_g Tested



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOW360A70	TO262	Tube	1000
AOWF360A70	TO262F	Tube	1000

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOW360A70	AOWF360A70	Units
Drain-Source Voltage	V_{DS}	700		V
Gate-Source Voltage	V_{GS}		± 20	V
Continuous Drain Current ^{$T_C=25^\circ\text{C}$}	I_D	12	12*	A
^{$T_C=100^\circ\text{C}$}		7.6	7.6*	
Pulsed Drain Current ^C	I_{DM}	48		
Avalanche Current ^C $L=1\text{mH}$	I_{AR}	3.4		A
Repetitive avalanche energy ^C	E_{AR}	5.8		mJ
Single pulsed avalanche energy ^G	E_{AS}	50		mJ
MOSFET dv/dt ruggedness	dv/dt	100		V/ns
Peak diode recovery dv/dt		20		
Power Dissipation ^B $T_C=25^\circ\text{C}$	P_D	156	29.5	W
Derate above 25°C		1.25	0.23	W/°C
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300		°C

Thermal Characteristics

Parameter	Symbol	AOW360A70	AOWF360A70	Units
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	65	65	°C/W
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5	---	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.8	4.2	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	700			V
		I _D =250μA, V _{GS} =0V, T _J =150°C		800		
BV _{DSS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I _D =250μA, V _{GS} =0V		0.6		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =700V, V _{GS} =0V		1		μA
		V _{DS} =560V, T _J =125°C		10		
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA		4		V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =6A		0.316	0.36	Ω
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D =6A		10		S
V _{SD}	Diode Forward Voltage	I _S =6A, V _{GS} =0V		0.86	1.2	V
I _S	Maximum Body-Diode Continuous Current				12	A
I _{SM}	Maximum Body-Diode Pulsed Current ^c				48	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz		1360		pF
C _{oss}	Output Capacitance			34		pF
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 480V, f=1MHz		32		pF
C _{o(tr)}	Effective output capacitance, time related ^I			147		pF
C _{rss}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz		1.7		pF
R _g	Gate resistance	f=1MHz		2		Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =6A		22.5		nC
Q _{gs}	Gate Source Charge			9		nC
Q _{gd}	Gate Drain Charge			6.3		nC
T _{d(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =400V, I _D =6A, R _G =5Ω		24.5		ns
T _r	Turn-On Rise Time			17		ns
T _{d(off)}	Turn-Off DelayTime			34.5		ns
T _f	Turn-Off Fall Time			13		ns
T _{rr}	Body Diode Reverse Recovery Time	I _F =6A, dI/dt=100A/μs, V _{DS} =400V		310		ns
I _{rm}	Peak Reverse Recovery Current			24.5		A
Q _{rr}	Body Diode Reverse Recovery Charge			4.8		μC

A. The value of R_{qJA} is measured with the device in a still air environment with T_A=25° C.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C in a TO252 package, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C.

D. The R_{qJA} is the sum of the thermal impedance from junction to case R_{qJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

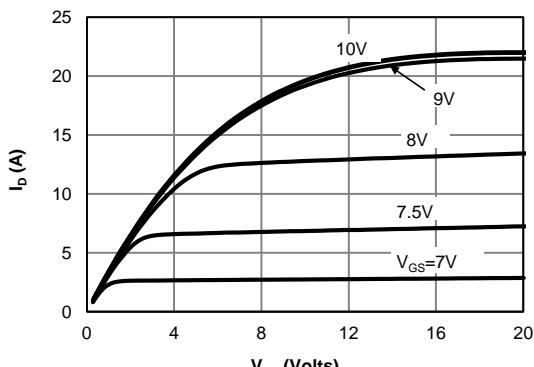
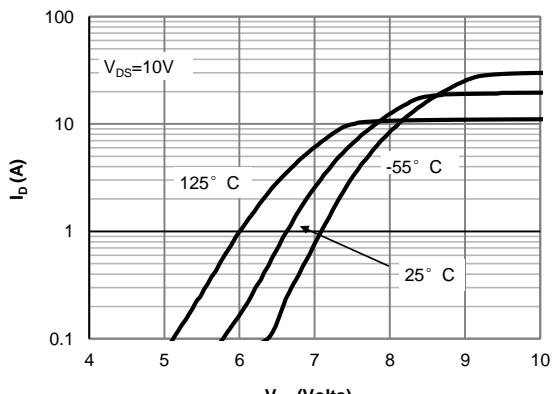
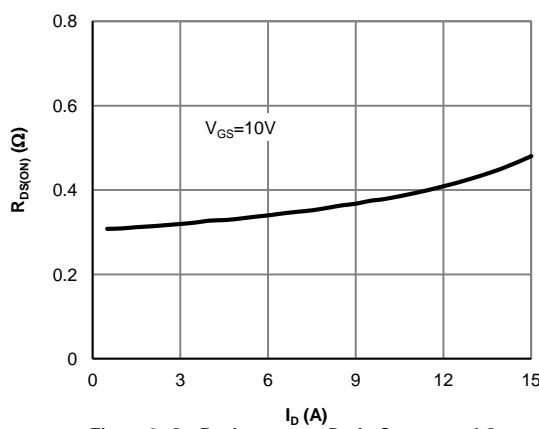
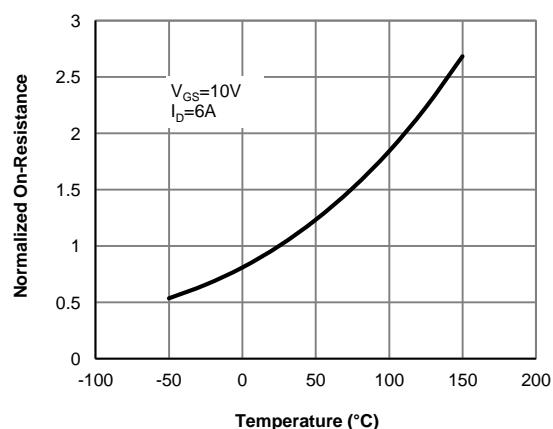
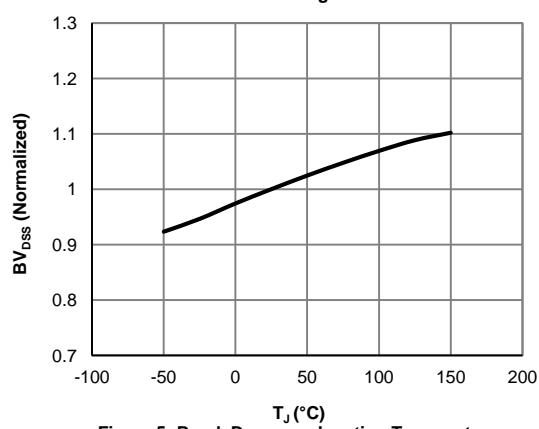
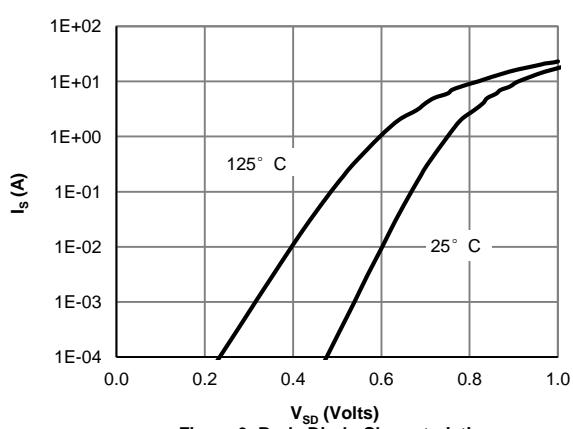
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

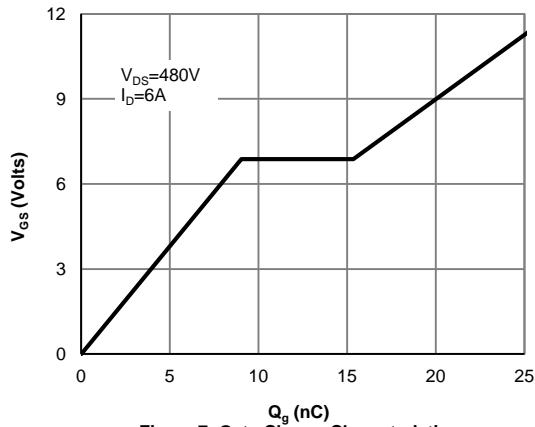
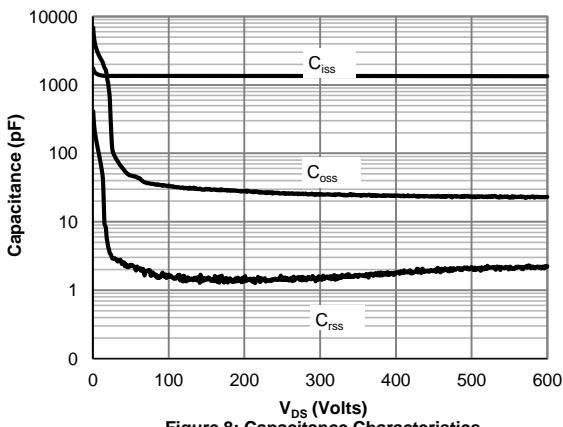
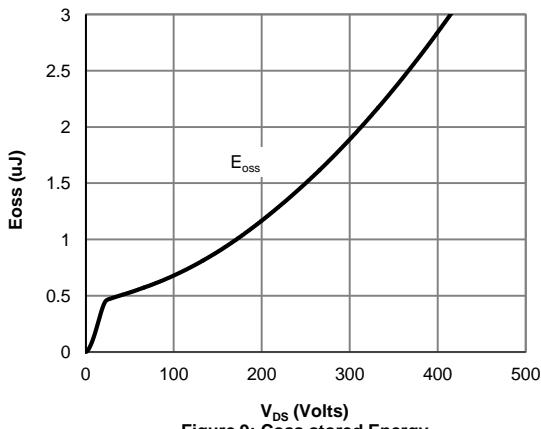
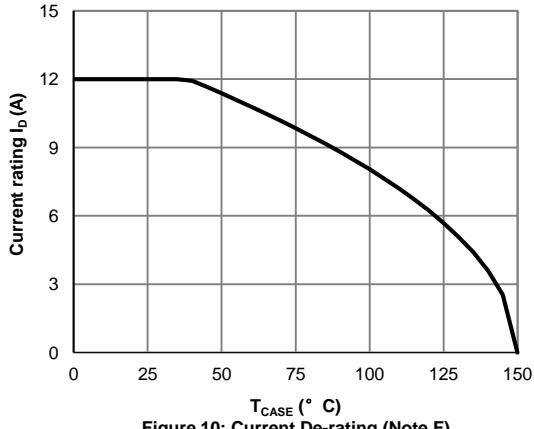
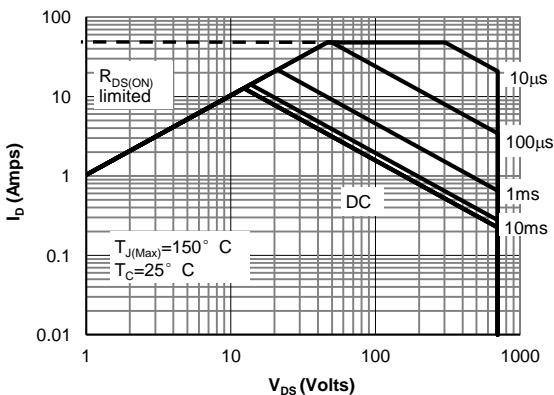
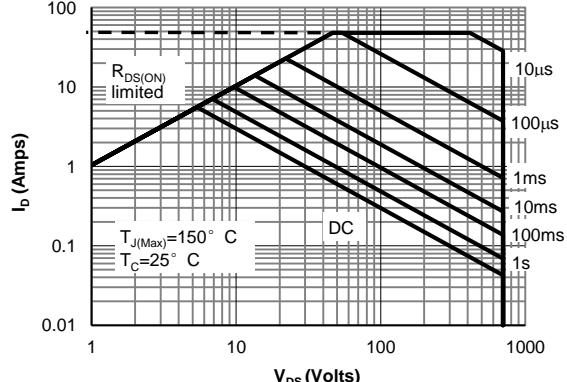
G. L=60mH, I_{AS}=1.3A, R_G=25Ω, Starting T_J=25° C.

H. C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

I. C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: Break Down vs. Junction Temperature

Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Coss stored Energy

Figure 10: Current De-rating (Note F)

Figure 11: Maximum Forward Biased Safe Operating Area for AOW360A70 (Note F)

Figure 12: Maximum Forward Biased Safe Operating Area for AOWF360A70 (Note F)

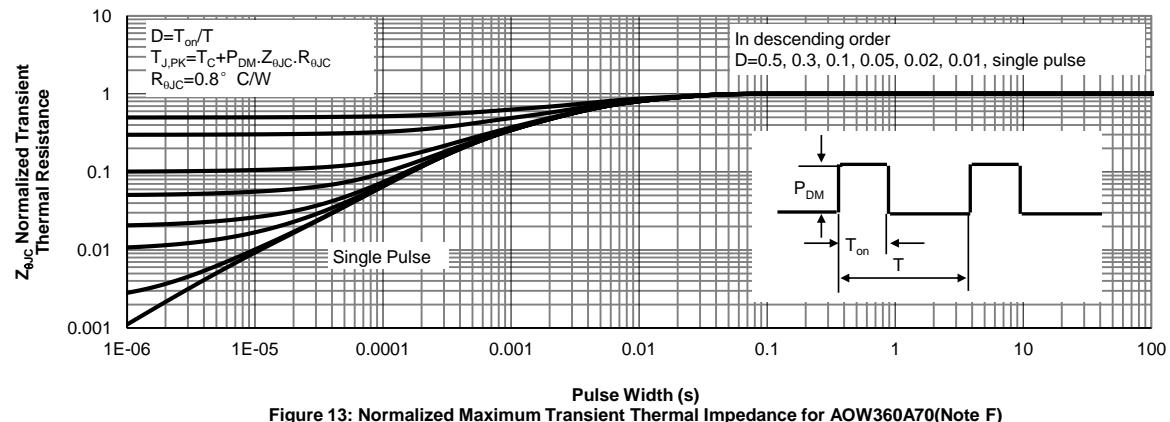
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 13: Normalized Maximum Transient Thermal Impedance for AOW360A70 (Note F)

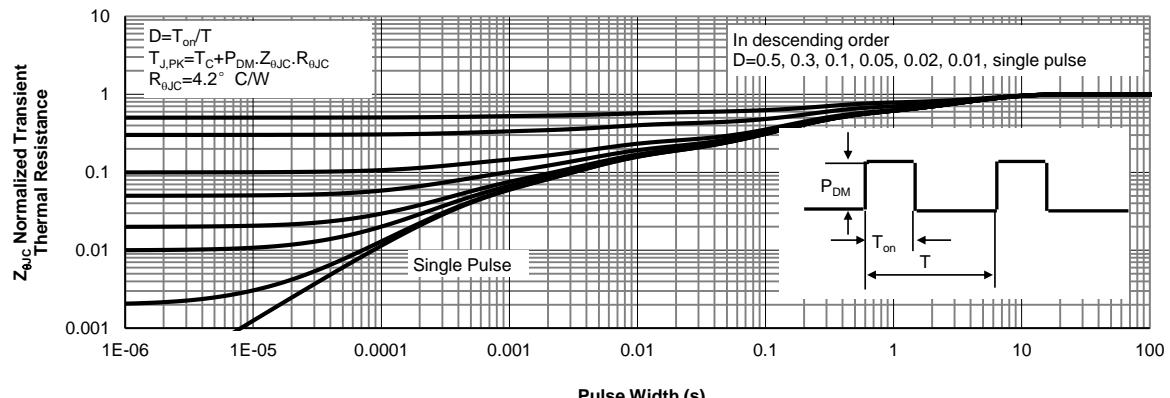
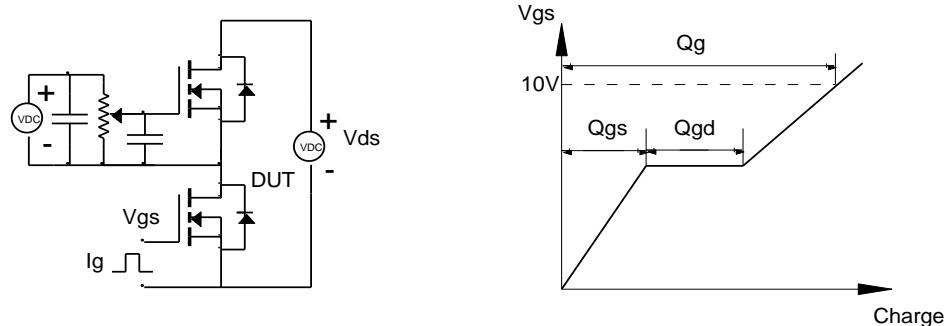
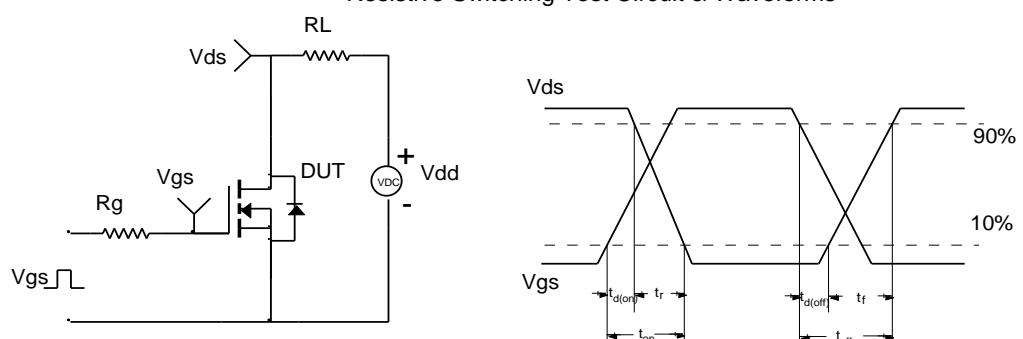
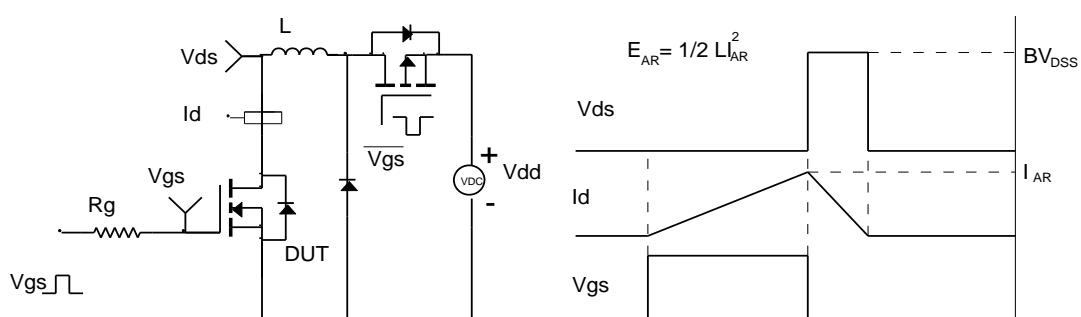


Figure 14: Normalized Maximum Transient Thermal Impedance for AOWF360A70 (Note F)

Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms
